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N-Channel PowerTrench [®] SyncFET TM	
25 V, 49 A, 2.9 mΩ	
Features Gene	neral De
$= Max T_{DS(on)} = 2.5 T_{S2} at V_{GS} = 10 V, T_{D} = 25 A$	FDMS75
	er convers age tech
and high efficiency device	on) while r ce has the diode.
SyncFET Schottky Body Diode	
■ MSL1 robust package design Appl	olicatio
■ 100% UIL tested Syr	nchronou

RoHS Compliant

FAIRCHILD

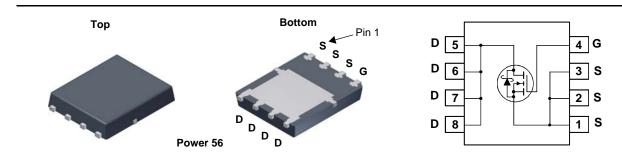


escription

572S has been designed to minimize losses in rsion application. Advancements in both silicon and nnologies have been combined to offer the lowest maintaining excellent switching performance. This he added benefit of an efficient monolithic Schottky

ons

- ous Rectifier for Synchronous Buck Converters
- Notebook
- Server
- Telecom
- High Efficiency DC-DC Switch Mode Power Supplies



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

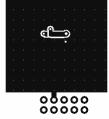
Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			25	V	
V _{GS}	Gate to Source Voltage		(Note 4)	±20	V	
	Drain Current -Continuous (Package limited)	T _C = 25 °C		49		
,	-Continuous (Silicon limited) $T_{C} = 25 \text{ °C}$			105	Α	
D	-Continuous	T _A = 25 °C	(Note 1a)	23	A	
	-Pulsed			150		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	84	mJ	
P _D	Power Dissipation	T _C = 25 °C		46	w	
	Power Dissipation	T _A = 25 °C	(Note 1a)	2.5	VV	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	
Thermal Ch	naracteristics					
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case			2.3	°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient		(Note 1a)	50	-C/w	

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS7572S	FDMS7572S	Power 56	13 "	12 mm	3000 units

October 2014

	Parameter	Test Conditions Mi		Тур	Max	Units
Off Chara	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 1 mA, V _{GS} = 0 V				V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 10 \text{ mA}$, referenced to 25 °C		19		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 20 V, V _{GS} = 0 V			500	μA
I _{GSS}	Gate to Source Leakage Current, Forward	d $V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA
On Chara	cteristics (Note 2)					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 1 \text{ mA}$ 1.		1.7	3.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 10 \text{ mA}, \text{ referenced to } 25 \text{ °C}$		-5		mV/°C
415	- •	V _{GS} = 10 V, I _D = 23 A		2.4	2.9	
r _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 18 \text{ A}$		3.4	4.2	mΩ
		V_{GS} = 10 V, I_{D} = 23 A, T_{J} = 125 °C		3.5	4.3	1
9 _{FS}	Forward Transconductance	V _{DS} = 5 V, I _D = 23 A		159		S
Dynamic C _{iss}	Characteristics Input Capacitance			2090	2780	pF
C _{oss}	Output Capacitance	V _{DS} = 13 V, V _{GS} = 0 V, f = 1 MHz		577	770	pF
C _{rss}	Reverse Transfer Capacitance			128	195	pF
	Gate Resistance			1.1	2.4	Ω
R _g				1.1	2.4	Ω
_{Rg} Switchinç	Gate Resistance Characteristics Turn-On Delay Time			1.1	2.4	Ω
R _g Switching t _{d(on)}	Characteristics	V _{DD} = 13 V, I _D = 23 A,		1	1	
R _g Switchinç t _{d(on)} t _r	Characteristics	$V_{DD} = 13 \text{ V}, \text{ I}_{D} = 23 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		10	20	ns
R _g Switching t _{d(on)} t _r	Turn-On Delay Time			10 4	20 10	ns ns
R _g Switching t _{d(on)} t _{d(off)} t _f	J Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time			10 4 27	20 10 43	ns ns ns
R _g Switching t _{d(on)} t _r t _{d(off)} t _f Q _g	y Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge	V_{GS} = 10 V, R_{GEN} = 6 Ω		10 4 27 3	20 10 43 10	ns ns ns ns
R _g Switchinç t _{a(on)} t _r t _{a(off)} t _f Q _g Q _g	J Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$		10 4 27 3 32	20 10 43 10 45	ns ns ns ns nC
R _g Switching t _f t _{d(on)} t _f Qg Qg Qg Qgs	y Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $V_{DD} = 13 \text{ V},$		10 4 27 3 32 15	20 10 43 10 45	ns ns ns nC nC
R _g Switching t _{d(on)} t _r t _{d(off)} t _f Q _g Q _g Q _{gs} Q _{gd}	Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Gate to Source Gate Charge	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $V_{DD} = 13 \text{ V},$		10 4 27 3 32 15 6.3	20 10 43 10 45	ns ns ns nC nC nC
Rg Switching t _{d(on)} t _r Qg Qg Qg Qgs Qgd Drain-Sou	Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Gate to Source Gate Charge Gate to Drain "Miller" Charge Ince Diode Characteristics	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $V_{DD} = 13 \text{ V},$		10 4 27 3 32 15 6.3	20 10 43 10 45	ns ns ns nC nC nC nC
R _g Switching t _d (on) t _r Qg Qg Qg Qgs Qgd	g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Gate to Source Gate Charge Gate to Drain "Miller" Charge	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $V_{DD} = 13 \text{ V},$ $I_{D} = 23 \text{ A}$		10 4 27 3 32 15 6.3 4.0	20 10 43 10 45 21	ns ns ns nC nC nC
Rg Switching tr tr Qg Qg Qgs Qgs Qgd Drain-Sou	Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Gate to Source Gate Charge Gate to Drain "Miller" Charge Ince Diode Characteristics	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $I_D = 13 \text{ V},$ $I_D = 23 \text{ A}$ $V_{GS} = 0 \text{ V}, \text{ I}_S = 2 \text{ A}$ (Note 2)		10 4 27 3 32 15 6.3 4.0	20 10 43 10 45 21	ns ns ns nC nC nC nC







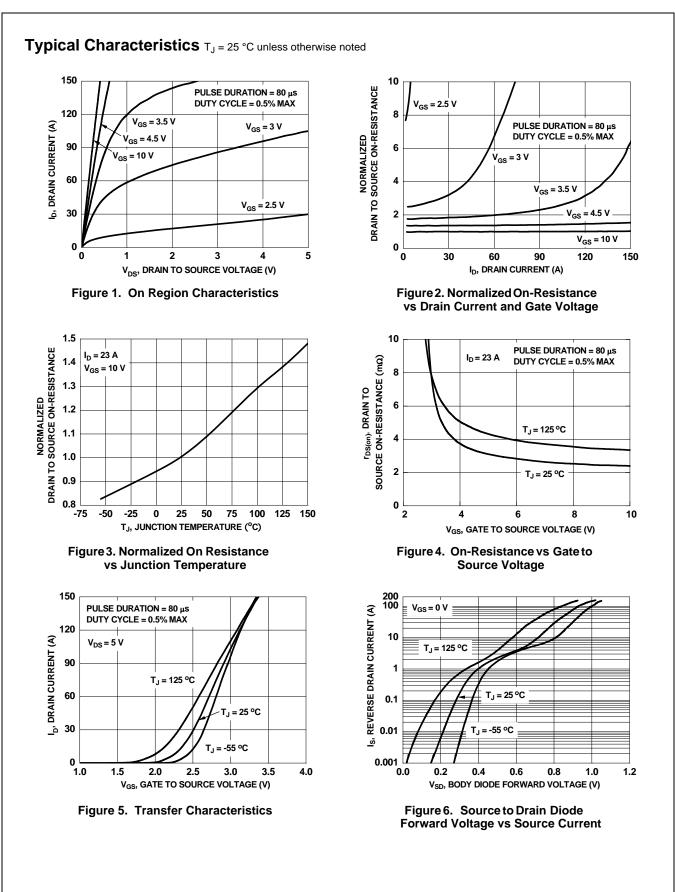
2. Pulse Test: Pulse Width < 300 μ s, Duty cycle < 2.0%.

3. E_{AS} of 84 mJ is based on starting T_J = 25 °C, L = 1 mH, I_{AS} = 13 A, V_{DD} = 23 V, V_{GS} = 10 V. 100% test at L = 0.3 mH, I_{AS} = 20 A.

4. As an N-ch device, the negative Vgs rating is for low duty cycle pulse occurrence only. No continuous rating is implied.

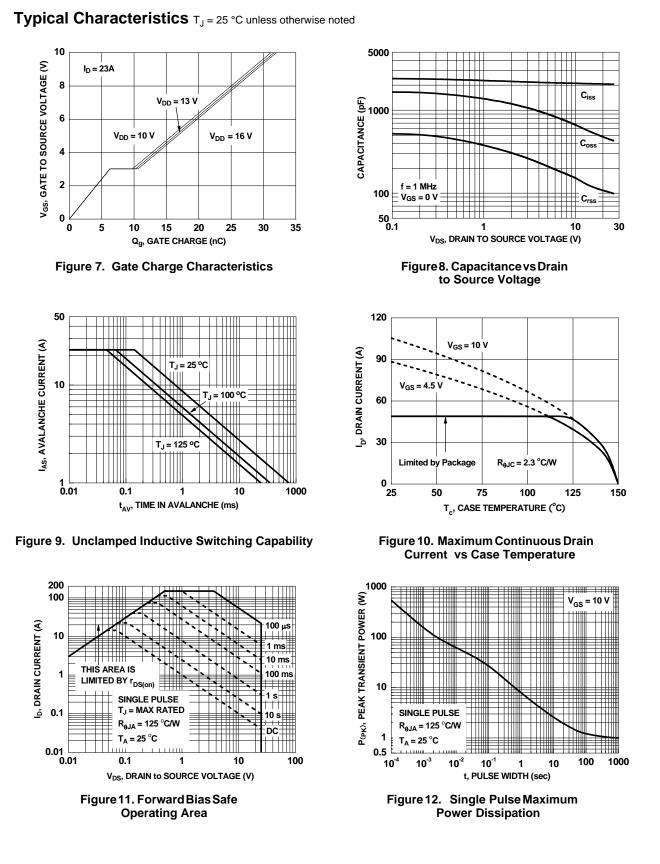
FDMS7572S Rev.C2

FDMS7572S N-Channel PowerTrench[®] SyncFET



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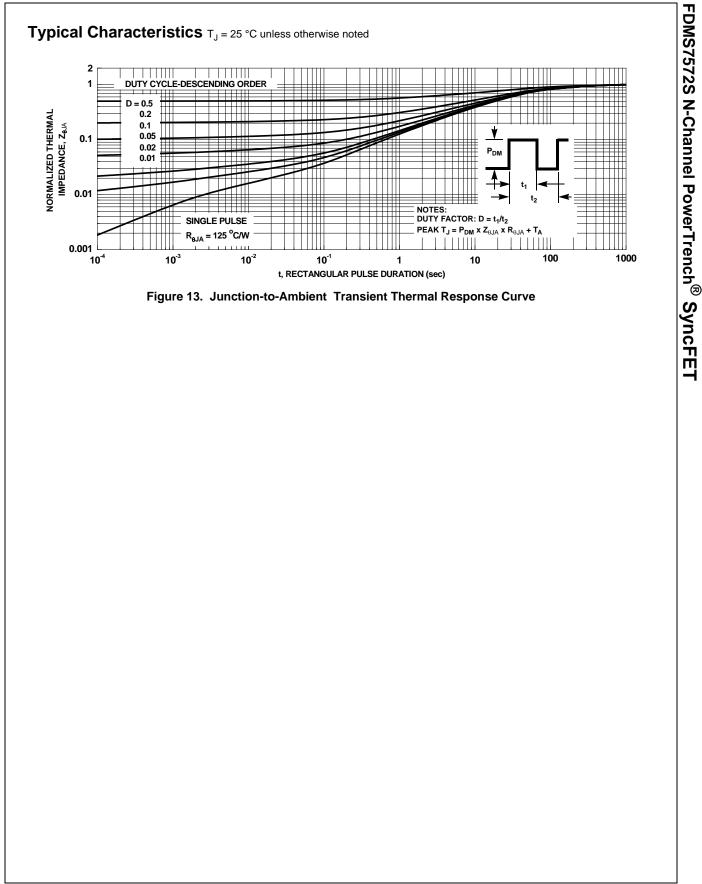
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Typical Characteristics (continued)

SyncFET Schottky body diode Characteristics

Fairchild's SyncFET process embeds a Schottky diode in parallel with PowerTrench MoSFET. This diode exhibits similar characteristics to a discrete external Schottky diode in parallel with a MOSFET. Figure 14 shows the reverses recovery characteristic of the FDMS7572S.

Schottky barrier diodes exhibit significant leakage at high temperature and high reverse voltage. This will increase the power in the device.

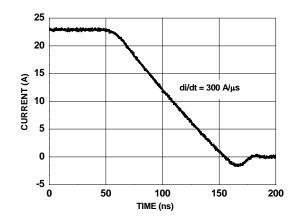
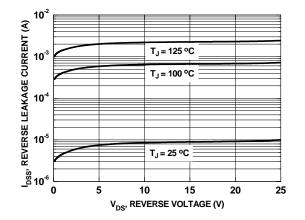
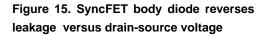
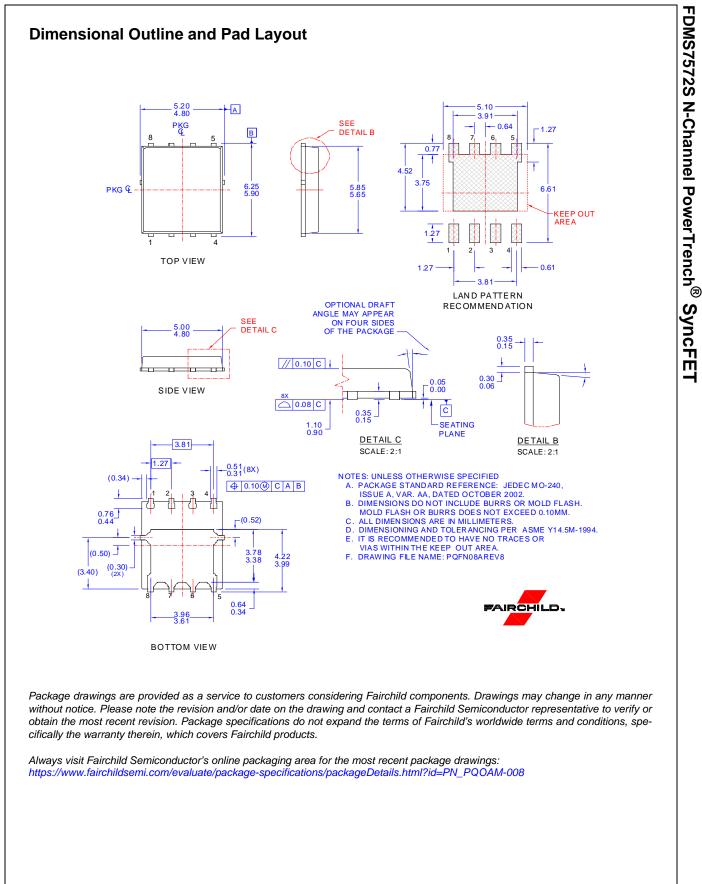
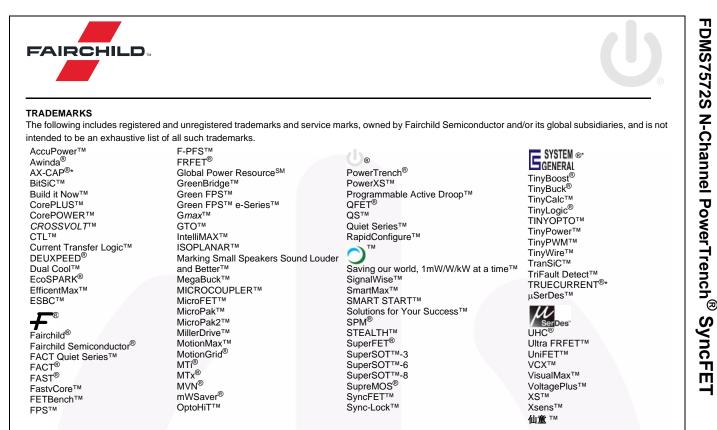


Figure 14. FDMS7572S SyncFET body diode reverse recovery characteristic









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